

FEATURES

- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 6.3 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot) >2 V at V_{CC} = 3.3 V, T_A = 25°C
- I_{off} Supports Partial-Power-Down Mode Operation
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{cc})
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DESCRIPTION/ORDERING INFORMATION

This octal bus transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

ORDERING INFORMATION

T _A	PACKA	GE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	TSSOP – PW	Reel of 2000	SN74LVC245AIPWREP	C245AEP

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 1000-V Charged-Device Model (C101)

P		PACK OP VII		_
DIR [1	υ	20	v _{cc}
A1 [2		19] OE
A2 [3		18] B1
A3 [4		17] B2
A4 [5		16] B3
A5 [6		15	B4
A6 [7		14	B5
A7 [8		13] B6
A8 [9		12	B7
GND [10)	11] в8

SN74LVC245A-EP OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

TEXAS INSTRUMENTS www.ti.com

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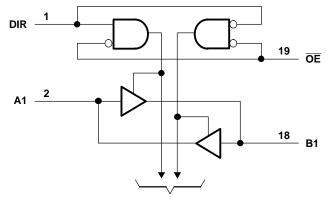
DESCRIPTION/ORDERING INFORMATION (CONTINUED)

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

FUNCTION TABLE

INP	UTS	OPERATION
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
н	Х	Isolation

LOGIC DIAGRAM (POSITIVE LOGIC)



To Seven Other Channels

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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	6.5	V
VI	Input voltage range ⁽²⁾		-0.5	6.5	V
Vo	Voltage range applied to any output in the	e high-impedance or power-off state ⁽²⁾	-0.5	6.5	V
Vo	Voltage range applied to any output in the	e high or low state ⁽²⁾⁽³⁾	-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
I _O	Continuous output current			±50	mA
	Continuous current through V_{CC} or GND			±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾			83	°C/W
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V_{CC} is provided in the recommended operating conditions table.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions⁽¹⁾

			T _A = 2	25°C	–40°C to	o 85°C	
			MIN	MAX	MIN	MAX	UNIT
V	Supply voltage	Operating	1.65	3.6	1.65	3.6	V
V _{CC}	Supply voltage	Data retention only	1.5		1.5		v
		V_{CC} = 1.65 V to 1.95 V	$0.65 imes V_{CC}$		$0.65 imes V_{CC}$		
V _{IH}	High-level input voltage	V_{CC} = 2.3 V to 2.7 V	1.7		1.7		V
		V_{CC} = 2.7 V to 3.6 V	2		2		
		V_{CC} = 1.65 V to 1.95 V		$0.35 \times V_{\text{CC}}$		$0.35 imes V_{CC}$	
V _{IL}	Low-level input voltage	V_{CC} = 2.3 V to 2.7 V		0.7		0.7	V
l		V_{CC} = 2.7 V to 3.6 V		0.8		0.8	
VI	Input voltage		0	5.5	0	5.5	V
Vo	Output voltage		0	V _{CC}	0	V _{CC}	V
		V _{CC} = 1.65 V		-4		-4	
	High lovel output ourrent	$V_{CC} = 2.3 V$		-8		-8	mA
I _{OH}	High-level output current	$V_{CC} = 2.7 V$		-12		-12	ША
		$V_{CC} = 3 V$		-24		-24	
		V _{CC} = 1.65 V		4		4	
1		$V_{CC} = 2.3 V$		8		8	
I _{OL}	Low-level output current	V _{CC} = 2.7 V		12		12	mA
		$V_{CC} = 3 V$		24		24	
$\Delta t/\Delta v$	Input transition rise or fall rate			10		10	ns/V

 All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

SN74LVC245A-EP **OCTAL BUS TRANSCEIVER** WITH 3-STATE OUTPUTS

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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

-	PARAMETER	TEST CONDITIONS	N/	T _A =	25°C	–40°C to 85°C	UNIT
F	ARAINETER	TEST CONDITIONS	V _{cc}	MIN	TYP MAX	MIN MAX	UNIT
		I _{OH} = -100 μA	1.65 V to 3.6 V	$V_{CC} - 0.2$		V _{CC} – 0.2	
		$I_{OH} = -4 \text{ mA}$	1.65 V	1.29		1.2	
V		I _{OH} = -8 mA	2.3 V	1.9		1.7	V
V _{OH}		1 12	2.7 V	2.2		2.2	v
		$I_{OH} = -12 \text{ mA}$	3 V	2.4		2.4	
		I _{OH} = -24 mA	3 V	2.3		2.2	
		I _{OL} = 100 μA	1.65 V to 3.6 V		0.1	0.2	
		$I_{OL} = 4 \text{ mA}$	1.65 V		0.24	0.45	
V _{OL}		I _{OL} = 8 mA	2.3 V		0.3	0.7	V
		I _{OL} = 12 mA	2.7 V		0.4	0.4	
		I _{OL} = 24 mA	3 V		0.55	0.55	
I _I	Control inputs	V _I = 0 to 5.5 V	3.6 V		±1	±5	μA
I _{off}		V_{I} or $V_{O} = 5.5 V$	0		±1	±10	μA
$I_{OZ}^{(1)}$		$V_0 = 0$ to 5.5 V	3.6 V		±1	±10	μA
		$V_{I} = V_{CC}$ or GND	2.0.1/		1	10	A
I _{CC}		$\frac{1}{3.6 \text{ V} \le \text{V}_1} \le 5.5 \text{ V}^{(2)} \qquad \text{I}_0 = 0$	3.6 V		1	10	μA
ΔI_{CC}		One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND	2.7 V to 3.6 V		500	500	μΑ
Ci	Control inputs	$V_{I} = V_{CC}$ or GND	3.3 V		4		pF
Cio	A or B port	$V_{I} = V_{CC}$ or GND	3.3 V		5.5		pF

(1) For I/O ports, the parameter I_{OZ} includes the input leakage current. (2) This applies in the disabled state only.

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	V	T,	_A = 25°C	;	–40°C to	o 85°C	UNIT
PARAMETER	(INPUT)	(OUTPUT)	V _{cc}	MIN	TYP	MAX	MIN	MAX	UNIT
			$1.8 \text{ V} \pm 0.15 \text{ V}$	1	6	12.2	1	12.7	
	A or D	B or A	$2.5~\text{V}\pm0.2~\text{V}$	1	3.9	7.8	1	8.3	~~
t _{pd}	A or B	BUIA	2.7 V	1	4.2	7.1	1	7.3	ns
			$3.3~\textrm{V}\pm0.3~\textrm{V}$	1.5	3.8	6.1	1.5	6.3	
			$1.8 \text{ V} \pm 0.15 \text{ V}$	1	7	14.8	1	15.3	
	OE	4 an D	$2.5~\textrm{V}\pm0.2~\textrm{V}$	1	4.5	10	1	10.5	
t _{en}	UE	A or B	2.7 V	1	5.4	9.3	1	9.5	ns
			$3.3~\textrm{V}\pm0.3~\textrm{V}$	1.5	4.4	8.3	1.5	8.5	
			$1.8 \text{ V} \pm 0.15 \text{ V}$	1	7.8	16.5	1	17	
	OE	4 an D	$2.5~\textrm{V}\pm0.2~\textrm{V}$	1	4	9	1	9.5	
t _{dis}	ÛE	A or B	2.7 V	1	4.4	8.3	1	8.5	ns
			$3.3~\text{V}\pm0.3~\text{V}$	1.7	4.1	7.3	1.7	7.5	
t _{sk(o)}			$3.3 \text{ V} \pm 0.3 \text{ V}$					1	ns

Operating Characteristics

 $T_A = 25^{\circ}C$

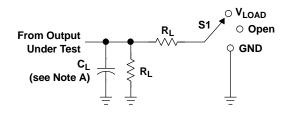
	PARAMETER		TEST CONDITIONS	V _{cc}	ТҮР	UNIT
				1.8 V	42	
		Outputs enabled		2.5 V	43	
0			6 40 MUL	3.3 V	45	- 5
C _{pd}	Power dissipation capacitance per transceiver		f = 10 MHz	1.8 V	1	pF
		Outputs disabled		2.5 V	1	
				3.3 V	2	

SN74LVC245A-EP OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

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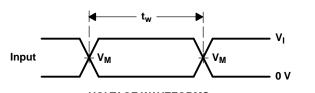
PARAMETER MEASUREMENT INFORMATION



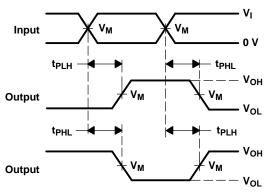
LOAD CIRCUIT

TEST	S1
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	VLOAD
t _{PHZ} /t _{PZH}	GND

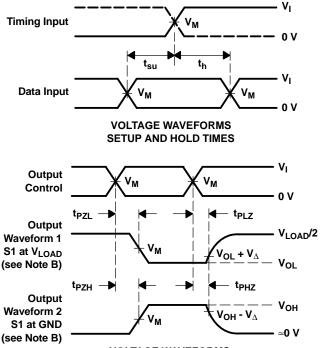
	INF	PUTS			•	_	
V _{CC}	VI	t _r /t _f	VM	V _{LOAD}	CL	RL	V_{Δ}
1.8 V \pm 0.15 V	V _{CC}	≤2 ns	V _{CC} /2	$2 \times V_{CC}$	30 pF	1 k Ω	0.15 V
$\textbf{2.5 V} \pm \textbf{0.2 V}$	V _{CC}	≤2 ns	V _{CC} /2	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



VOLTAGE WAVEFORMS PULSE DURATION



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω .
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins P	ackage Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LVC245AIPWREP	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/04737-01XE	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN74LVC245A-EP :

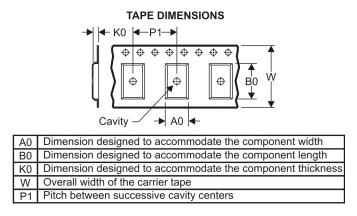
• Catalog: SN74LVC245A

NOTE: Qualified Version Definitions:

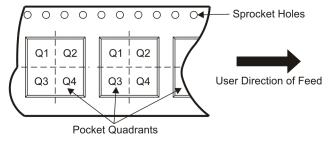
• Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



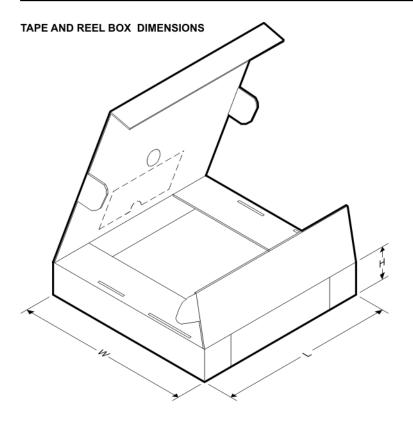
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins		Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVC245AIPWREP	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

26-Jul-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVC245AIPWREP	TSSOP	PW	20	2000	346.0	346.0	33.0

MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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